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## High Current MegaMOS ${ }^{\text {TM }}$ FET

## N-Channel Enhancement Mode

| Symbol | Test conditions | Maximum ratings |  |
| :---: | :---: | :---: | :---: |
|  |  |  |  |
| $\mathrm{V}_{\text {DSs }}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ | 100 | V |
| $\mathrm{V}_{\text {DGR }}$ | $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C} ; \mathrm{R}_{\mathrm{GS}}=1.0 \mathrm{M} \Omega$ | 100 | V |
| $\mathrm{V}_{\text {GS }}$ | Continuous | $\pm 20$ | V |
| $\mathrm{V}_{\text {GSM }}$ | Transient | $\pm 30$ | V |
| $\mathrm{I}_{\mathrm{D} 25}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ MOSFET chip capability | 250 | A |
| $\mathrm{I}_{\mathrm{D} \text { (RMS) }}$ | External lead current limit | 75 | A |
| $\mathrm{I}_{\mathrm{DM}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, pulse width limited by $\mathrm{T}_{\mathrm{JM}}$ | 1000 | A |
| $\mathrm{I}_{\text {AR }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 90 | A |
| $\mathrm{E}_{\text {AR }}$ | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ | 80 | mJ |
| $\mathrm{E}_{\text {AS }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 4.0 | J |
| dv/dt | $\begin{array}{ll} \mathrm{I}_{\mathrm{S}} & \leq \mathrm{I}_{\mathrm{DM}}, \mathrm{di} / \mathrm{dt} \leq 100 \mathrm{~A} / \mu \mathrm{s}, \mathrm{~V}_{\mathrm{DD}} \leq \mathrm{V}_{\mathrm{DSS}} \\ \mathrm{~T}_{J} \leq 150^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{G}}=2 \Omega \end{array}$ | 5 | V/ns |
| $\mathrm{P}_{\mathrm{D}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 730 | W |
| $\mathrm{T}_{J}$ |  | .. +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{JM}}$ |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ |  | .. +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | 1.6 mm (0.063 in.) from case for 10 s | 300 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{M}_{\mathrm{d}}$ | Mounting torque | 0.7/6 | Nm/lb.in. |
| Weight | TO-264 | 10 | g |

Symbol Test Conditions

| ( $\mathrm{T}_{\mathrm{J}}=2$ | unless otherwise specified) | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DSs}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ | 100 |  | V |
| $\mathrm{V}_{\text {GS(th) }}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 2.0 |  | 4.0 V |
| $\mathrm{I}_{\text {Gss }}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V} D C, \mathrm{~V}_{\mathrm{DS}}=0$ |  |  | $\pm 200 \mathrm{nA}$ |
| $\mathrm{I}_{\text {DSS }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{DSS}} \\ & \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \mathrm{T}_{J}=25^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{array}{rr} 50 & \mu \mathrm{~A} \\ 1 & \mathrm{~mA} \end{array}$ |
| $\mathrm{R}_{\mathrm{DS}(\text { on) }}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=90 \mathrm{~A}$ <br> Pulse test, $\mathrm{t} \leq 300 \mathrm{~ms}$, duty | le $d \leq 2 \%$ |  | $5 \mathrm{~m} \Omega$ |

## IXTK 250N10



TO-264 AA (IXTK)

$\mathrm{G}=$ Gate $\quad \mathrm{D}=$ Drain
$S=$ Source $\quad$ Tab $=$ Drain

## Features

- Low $\mathrm{R}_{\mathrm{DS}(\text { on) }} \mathrm{HDMOS}^{\text {TM }}$ process - Rugged polysilicon gate cell structure
- International standard package
- Fast switching times


## Applications

- Motor controls
- DC choppers
- Switched-mode power supplies
- DC-DC Converters
- Linear Regulators


## Advantages

- Easy to mount with one screw (isolated mounting screw hole)
- Space savings
- High power density

Symbol Test Conditions

| ( $\mathrm{T}_{\mathrm{j}}=$ | unless otherwise specified) Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: |
| $\mathrm{g}_{\text {ts }}$ | $\mathrm{V}_{\text {DS }}=10 \mathrm{~V} ; \mathrm{I}_{\mathrm{D}}=90 \mathrm{~A}$, pulse test $\quad 75$ | 110 | S |
| $\begin{aligned} & \mathrm{C}_{\text {iss }} \\ & \mathrm{C}_{\text {oss }} \\ & \mathrm{C}_{\mathrm{rss}} \end{aligned}$ | $\} \mathrm{v}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{v}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\begin{array}{r} 12700 \\ 3700 \\ 1490 \end{array}$ | pF pF pF |
| $\begin{aligned} & t_{\text {dol(on) }} \\ & t_{r} \\ & t_{\text {dolf) }} \\ & t_{t} \end{aligned}$ |  | $\begin{array}{r} 35 \\ 40 \\ 120 \\ 55 \end{array}$ | ns ns ns ns |
| $\begin{aligned} & \mathbf{Q}_{\mathrm{glon})} \\ & \mathrm{Q}_{\mathrm{gs}} \\ & \mathrm{Q}_{\mathrm{gd}} \end{aligned}$ | $\} \mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0.5 \mathrm{~V}_{\mathrm{DSS}}, \mathrm{I}_{\mathrm{D}}=0.5 \mathrm{I}_{\mathrm{D} 25}$ | 430 70 225 | nC nc nC |
| $\begin{aligned} & \mathbf{R}_{\mathrm{thuc}} \\ & \mathbf{R}_{\mathrm{thck}} \end{aligned}$ |  | 0.15 | $\begin{array}{r} 0.17 \text { KW } \\ \text { KW } \end{array}$ |

## Source-Drain Diode

Ratings and Characteristics
( $T_{J}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| Symbol | Test Conditions | Min. | Typ. | Max. |  |
| :--- | :--- | ---: | ---: | ---: | :--- |
| $\mathbf{I}_{\mathrm{s}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | 250 | A |  |
| $\mathbf{I}_{\mathrm{SM}}$ | Repetitive; pulse width limited by $\mathrm{T}_{\mathrm{JM}}$ |  | 1000 | A |  |
| $\mathbf{V}_{\mathrm{SD}}$ | $\mathrm{I}_{\mathrm{F}}=90 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$, |  |  |  |  |
|  | Pulse test, $\mathrm{t} \leq 300 \mathrm{~s}$, duty cycle $\mathrm{d} \leq 2 \%$ |  | 1.2 | V |  |
| $\mathbf{t}_{\mathrm{rr}}$ | $\mathrm{I}_{\mathrm{F}}=30 \mathrm{~A},-\mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ |  |  |  |  |
| $\mathbf{Q}_{\mathrm{rr}}$ |  | 150 |  | ns |  |

Min. Typ. Max.

## TO-264 AA Outline



| Dim. | Millimeter |  | Inches |  |
| :--- | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |
| A | 4.82 | 5.13 | .190 | .202 |
| A1 | 2.54 | 2.89 | .100 | .114 |
| A2 | 2.00 | 2.10 | .079 | .083 |
| b | 1.12 | 1.42 | .044 | .056 |
| b1 | 2.39 | 2.69 | .094 | .106 |
| b2 | 2.90 | 3.09 | .114 | .122 |
| c | 0.53 | 0.83 | .021 | .033 |
| D | 25.91 | 26.16 | 1.020 | 1.030 |
| E | 19.81 | 19.96 | .780 | .786 |
| e | 5.46 BSC | .215 BSC |  |  |
| J | 0.00 | 0.25 | .000 | .010 |
| K | 0.00 | 0.25 | .000 | .010 |
| L | 20.32 | 20.83 | .800 | .820 |
| L1 | 2.29 | 2.59 | .090 | .102 |
| P | 3.17 | 3.66 | .125 | .144 |
| Q | 6.07 | 6.27 | .239 | .247 |
| Q1 | 8.38 | 8.69 | .330 | .342 |
| R | 3.81 | 4.32 | .150 | .170 |
| R1 | 1.78 | 2.29 | .070 | .090 |
| S | 6.04 | 6.30 | .238 | .248 |
| T | 1.57 | 1.83 | .062 | .072 |

IXYS reserves the right to change limits, test conditions, and dimensions

Fig. 1. Output Characteristics
@ $\mathbf{2 5}^{\circ} \mathrm{C}$


Fig. 3. Output Characteristics
@ $\mathbf{1 2 5}^{\circ} \mathrm{C}$


Fig. 5. Drain Current vs. Case Temperature


Fig. 2. Extended Output Characteristics @ $\mathbf{2 5}^{\circ} \mathrm{C}$


Fig. 4. Norm alized $\mathrm{R}_{\mathrm{DS}(o n)} \mathrm{vs}$. Junction Temperature


Fig. 6. Input Admittance


Fig. 7. Transconductance


Fig. 9. Gate Charge


Fig. 11. Forw ard-Bias
Safe Operating Area


Fig. 8. Source Current vs
Source-To-Drain Voltage


Fig. 10. Capacitance


Fig. 12. Maxim um Transient Thermal Resistance


IXYS reserves the right to change limits, test conditions, and dimensions.

| IXYS MOSFETs and IGBTs are covered by one or more | $4,850,072$ | $4,931,844$ | $5,034,796$ | $5,063,307$ | $5,237,481$ | $5,381,025$ | $6,404,065 B 1$ | $6,162,665$ | $6,534,343$ | $6,583,505$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| of the following U.S. patents: | $4,835,592$ | $4,881,106$ | $5,017,508$ | $5,049,961$ | $5,187,117$ | $5,486,715$ | $6,306,728 B 1$ | $6,259,123 B 1$ | $6,306,728 B 1$ | $6,683,344$ |

